

LED Drivers for LCD Backlights





White backlight LED Drivers for Small to Medium LCD Panels (Switching Regulator Type)

BD60910GU No.11040EBT30

Description

BD60910GU is maximum 8LED(minimum 4LED) serial LED driver with ALC (Auto Luminous Control) function. Best match for mobile application that needs long battery life.

Features

1) Boost DC/DC for LED back lighting

Drives maximum 8 to minimum 4 serial LEDs.

Integrated high voltage switching transistor

Soft start function.

Over voltage protection (Detect voltage is controllable)

Over current protection (2nd side)

VOUT short to GND protection

VOUT open protection.

2) Constant current driver for LED back lighting

Current step can be set in 7bit(0.2mA 128steps), and 8bit(0.1mA 256steps) in sloping.

Rise and fall time of sloping are set independently.

lout max = 25.6mA

PWM brightness control by external input.

3) Auto Luminous Control (ALC)

Periodic ambient detection reduces sensor consumption current.

LED brightness can be controlled by 16steps ambient brightness level.

LED current for each ambient level is freely customizable.

SBIAS for sensor bias is integrated. (3.0V or 2.6V)

Photo Diode, Photo Transistor, Photo IC(Linear/Logarithm) can be connected.

Automatic gain control built-in, so BH1600FVC can be connected directly.

- 4) Thermal shutdown (Auto-return type)
- 5) I²C BUS FS mode (max 400kHz) Write/Read
- 6) VCSP85H3(3.00mm x 3.00mm) Small Size CSP package

● Absolute Maximum Ratings (Ta=25 °C)

Parameter	Symbol	mbol Ratings		Pins
Maximum voltage 1	VMAX1	7	V	except for VLED VOUT, SW
Maximum voltage 2	VMAX2	15	V	VLED
Maximum voltage 3	VMAX3	40	V	VOUT, SW
Power Dissipation	Pd	1250 ^{*1}	mW	
Operating Temperature Range	Topr	-40 ~ +85	°C	
Storage Temperature Range	Tstg	-55 ~ +150	°C	

^{*1)} Power dissipation deleting is 10mW/ °C, when it's used in over 25 °C. It's deleting is on the board that is ROHM's standard. Dissipation by LSI should not exceed tolerance level of Pd.

Operating conditions (VBAT≥VIO, Ta=-40~85 °C)

Parameter	Symbol	Ratings	Unit
VBAT input voltage	VBAT	2.7~5.5	V
VIO pin voltage	VIO	1.65~3.3	V

● Electrical Characteristics (Unless otherwise specified, Ta=25°C, VBAT=3.6V, VIO=1.8V)

Parameter	Symbol		Limits		Unit	Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
[Circuit Current]							
VBAT Circuit current 1	IBAT1	-	0.1	1.0	μA	RESETB=0V, VIO=0V	
VBAT Circuit current 2	IBAT2	-	0.5	3.0	μA	RESETB=0V, VIO=1.8V	
VBAT Circuit current 3	IBAT3	-	3.5	5.0	mA	LED=ON, ILED=15mA setting Vo=24V	
VBAT Circuit current 4	IBAT4	-	0.4	1.0	mA	Only ALC block ON ADCYC=0.52s setting Except sensor current	
[LED Driver]							
LED current Step (Setup)	ILEDSTP1		128		Step		
LED current Step (At slope)	ILEDSTP2	256			Step		
LED Maximum current	IMAXWLED	-	25.6	-	mA		
LED current accuracy	IWLED	-7%	15	+7%	mA	I _{LED} =15mA setting	
[DC/DC]				l .	l .	1	
VLED pin feedback voltage	Vfb	-	0.3	-	V		
Over current protection	OCP	-	650	-	mA		
Oscillator frequency	fosc	0.8	1.0	1.2	MHz		
	OVP1	30	31	32	V		
Over Valtage Protection datast	OVP2	-	27	-	V		
Over Voltage Protection detect voltage	OVP3	-	24	-	V		
	OVP4	-	21	-	V		
	OVP5	-	18	-	V		
Maximum Duty	Mduty	92.5	-	-	%		
VOUT open protection	OVO	-	0.7	1.4	V		

● Electrical Characteristics (Unless otherwise specified, Ta=25°C, VBAT=3.6V, VIO=1.8V)

Parameter	Cumbal		Limits		Unit	Condition
Farameter	Symbol	Min.	Тур.	Max.	Offic	Condition
[I ² C Input (SDA, SCL)]						
LOW level input voltage	VIL	-0.3	-	0.25 × VIO	V	
HIGH level input voltage	VIH	0.75 × VIO	-	VBAT +0.3	V	
Hysteresis of Schmitt trigger input	Vhys	0.05 × VIO	-	-	V	
LOW level output voltage (SDA) at 3mA sink current	VOL	0	-	0.3	V	
Input current each I/O pin	lin	-3	-	3	μΑ	Input voltage = 0.1×VIO~0.9×VIO
[RESETB]						
LOW level input voltage	VIL	-0.3	-	0.25 × VIO	V	
HIGH level input voltage	VIH	0.75 × VIO	-	VBAT +0.3	V	
Input current each I/O pin	lin	-3	-	3	μA	Input voltage = 0.1xVIO~0.9xVIO

● Electrical Characteristics (Unless otherwise specified, Ta=25°C, VBAT=3.6V, VIO=1.8V)

Parameter	Symbol		Limits		Unit	Condition
Faidilletei	Symbol	Min.	Тур.	Max.	Offic	Condition
[ALC]						
SBIAS Output voltage	VoS	2.850	3.0	3.150	V	lo=200µA <initial value=""></initial>
CDINC Output Voltage	700	2.470	2.6	2.730	V	lo=200μA
SBIAS Output current	loS	-	-	30	mA	Vo=3.0V
SSENS Input range	VISS	0	-	VoS x 255/256	V	
SBIAS Discharge resister at OFF	ROFFS	-	1.0	1.5	kΩ	
ADC resolution	ADRES		8		bit	
ADC non-linearity error	ADINL	-3	-	+3	LSB	
ADC differential non-linearity error	ADDNL	-1	-	+1	LSB	
SSENS Input impedance	RSSENS	1	-	-	МΩ	
[WPWMIN]						
L level input voltage	VILA	-0.3	-	0.3	V	
H level input voltage	VIHA	1.4	-	VBAT +0.3	V	
Input current	linA	-	3.6	10	μΑ	Vin=1.8V
PWM input minimum High pulse width	PWpwm	50	-	-	μs	
[GC1, GC2]	•		,			
L level output voltage	VOLS	-	-	0.2	V	IOL=1mA
H level output voltage	VOHS	VoS -0.2	-	-	V	IOH=1mA

●Block Diagram / Application Circuit example

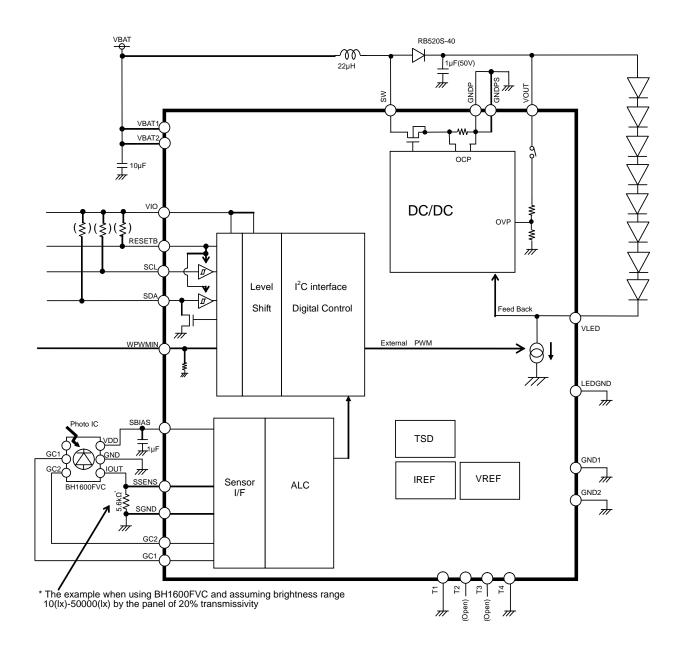


Fig.1 Block Diagram / Application Circuit example

●Pin Arrangement [Bottom View]

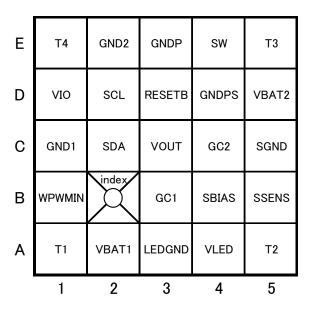
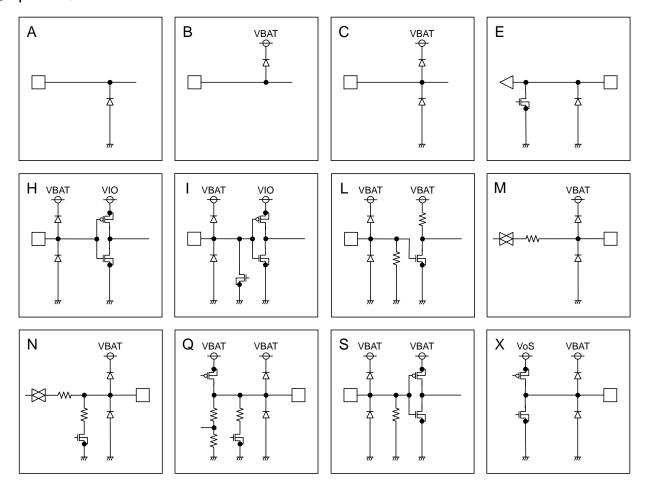


Fig.2 Pin Arrangement

●Pin Functions

NI-	D-II N-	Dia Nama	1/0	ESD	Diode	Finations	Equivalent
No	Ball No.	Pin Name	I/O	For Power	For Ground	Functions	Circuit
1	A2	VBAT1	-	-	GND	Power supply	A
2	D5	VBAT2	-	-	GND	Power supply	A
3	D1	VIO	-	VBAT	GND	Power supply for I/O	С
4	C1	GND1	-	VBAT	-	Ground	В
5	E2	GND2	-	VBAT	-	Ground	В
6	A3	LEDGND	-	VBAT	-	Ground	В
7	E3	GNDP	-	VBAT	-	Ground	В
8	D4	GNDPS	-	VBAT	-	Ground	В
9	C5	SGND	-	VBAT	-	Ground	В
10	D3	RESETB	I	VBAT	GND	Reset input (L: reset, H: reset cancel)	Н
11	C2	SDA	I/O	VBAT	GND	I ² C data input / output	į.
12	D2	SCL	1	VBAT	GND	I ² C clock input	Н
13	B1	WPWMIN	I	VBAT	GND	External PWM input	L
14	E4	SW	0	-	GND	DC/DC Switching port	A
15	C3	VOUT	0	-	GND	DC/DC output voltage monitor	A
16	A4	VLED	I	-	GND	LED cathode connection	E
17	B4	SBIAS	0	VBAT	GND	Bias output for the Ambient Light Sensor	Q
18	B5	SSENS	I	VBAT	GND	Ambient Light Sensor input	N
19	В3	GC1	0	VBAT	GND	Ambient Light Sensor gain control output 1	Х
20	C4	GC2	0	VBAT	GND	Ambient Light Sensor gain control output 2	Х
21	A1	T1	I	VBAT	GND	Test Input Pin (short to Ground)	S
22	A5	T2	0	VBAT	GND	Test Output Pin (Open)	М
23	E5	Т3	0	VBAT	GND	Test Output Pin (Open)	N
24	E1	T4	I	VBAT	GND	Test Input Pin (short to Ground)	S

● Equivalent Circuit



●I²C BUS format

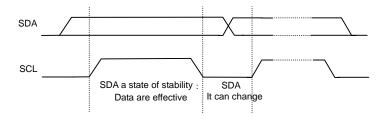
The writing/reading operation is based on the I²C slave standard.

· Slave address

A7	A6	A5	A4	A3	A2	A1	R/W
1	1	1	0	1	1	0	1/0

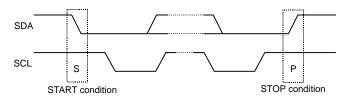
· Bit Transfer

SCL transfers 1-bit data during H. SCL cannot change signal of SDA during H at the time of bit transfer. If SDA changes while SCL is H, START conditions or STOP conditions will occur and it will be interpreted as a control signal.



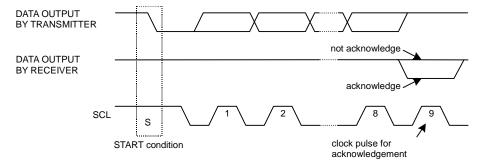
START and STOP condition

When SDA and SCL are H, data is not transferred on the I^2 C- bus. This condition indicates, if SDA changes from H to L while SCL has been H, it will become START (S) conditions, and an access start, if SDA changes from L to H while SCL has been H, it will become STOP (P) conditions and an access end.



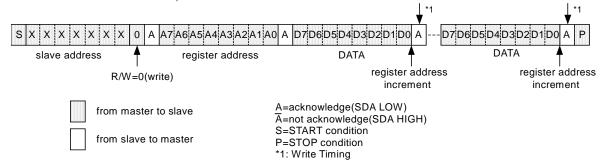
Acknowledge

It transfers data 8 bits each after the occurrence of START condition. A transmitter opens SDA after transfer 8bits data, and a receiver returns the acknowledge signal by setting SDA to L.



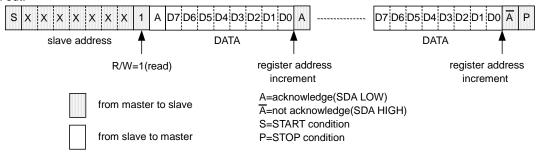
· Writing protocol

A register address is transferred by the next 1 byte that transferred the slave address and the write-in command. The 3rd byte writes data in the internal register written in by the 2nd byte, and after 4th byte or, the increment of register address is carried out automatically. However, when a register address turns into the last address, it is set to 00h by the next transmission. After the transmission end, the increment of the address is carried out.



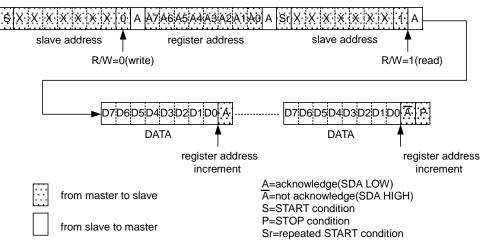
Reading protocol

It reads from the next byte after writing a slave address and R/W bit. The register to read considers as the following address accessed at the end, and the data of the address that carried out the increment is read after it. If an address turns into the last address, the next byte will read out 00h. After the transmission end, the increment of the address is carried out.



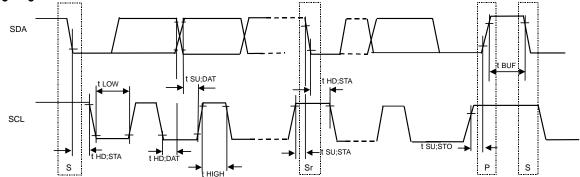
Multiple reading protocols

After specifying an internal address, it reads by repeated START condition and changing the data transfer direction. The data of the address that carried out the increment is read after it. If an address turns into the last address, the next byte will read out 00h. After the transmission end, the increment of the address is carried out.



As for reading protocol and multiple reading protocols, please do \overline{A} (not acknowledge) after doing the final reading operation. It stops with read when ending by A(acknowledge), and SDA stops in the state of Low when the reading data of that time is 0. However, this state returns usually when SCL is moved, data is read, and \overline{A} (not acknowledge) is done.

●Timing diagram



Electrical Characteristics (Unless otherwise specified, Ta=25 °C, VBAT=3.6V, VIO=1.8V)

Electrical Characteristics(Unless otherwise specified, Ta=25 °C, VBAT=3.6V, VIO=1.8V)											
Parameter	Cumbal	Sta	andard-m	ode	F	ast-mode		Unit			
Falametei	Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.	Utilit			
[I ² C BUS format]	[I ² C BUS format]										
SCL clock frequency	fscL	0	-	100	0	-	400	kHz			
LOW period of the SCL clock	tLOW	4.7	-	-	1.3	-	-	μs			
HIGH period of the SCL clock	tHIGH	4.0	-	-	0.6	-	-	μs			
Hold time (repeated) START condition After this period, the first clock is generated	thd;sta	4.0	-	-	0.6	-	-	μs			
Set-up time for a repeated START condition	tsu;sta	4.7	-	-	0.6	-	-	μs			
Data hold time	thd;dat	0	-	3.45	0	-	0.9	μs			
Data set-up time	tsu;dat	250	-	-	100	-	-	ns			
Set-up time for STOP condition	tsu;sto	4.0	-	-	0.6	-	-	μs			
Bus free time between a STOP and START condition	tBUF	4.7	-	-	1.3	-	-	μs			

●Register List

Input "0" for "-".

•	0 10				Regist	er data				
Address	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Function
00h	W	-	-	-	-	-	-	-	SFTRST	Software Reset
01h	R/W	-	VOVP(2)	VOVP(1)	VOVP(0)	WPWMEN	ALCEN	LEDMD	LEDEN	LED, ALC, OVP Control
02h	-	-	-	-	-	-	-	-	-	-
03h	R/W	-	ILED(6)	ILED(5)	ILED(4)	ILED(3)	ILED(2)	ILED(1)	ILED(0)	LED Current Setting at non-ALC mode
04h	-	-	-	-	-	-	-	-	-	-
05h	1	-	-	-	-	-	-	-	-	-
06h	1	-	-	-	-	-	-	-	-	-
07h	-	-	-	-	-	-	-	-	-	-
08h	W	THL(3)	THL(2)	THL(1)	THL(0)	TLH(3)	TLH(2)	TLH(1)	TLH(0)	LED Current transition
09h	1	-	-	-	-	-	-	-	-	-
0Ah	-	-	-	-	-	-	-	-	-	-
0Bh	R/W	ADCYC(1)	ADCYC(0)	GAIN(1)	GAIN(0)	STYPE	VSB	MDCIR	SBIASON	ALC mode setting
0Ch	-	-	-	-	-	-	-	-	-	-
0Dh	R	-	-	-	-	AMB(3)	AMB(2)	AMB(1)	AMB(0)	Ambient level output
0Eh	W	-	IU0(6)	IU0(5)	IU0(4)	IU0(3)	IU0(2)	IU0(1)	IU0(0)	LED Current at Ambient level 0h
0Fh	W	-	IU1(6)	IU1(5)	IU1(4)	IU1(3)	IU1(2)	IU1(1)	IU1(0)	LED Current at Ambient level 1h
10h	W	-	IU2(6)	IU2(5)	IU2(4)	IU2(3)	IU2(2)	IU2(1)	IU2(0)	LED Current at Ambient level 2h
11h	W	-	IU3(6)	IU3(5)	IU3(4)	IU3(3)	IU3(2)	IU3(1)	IU3(0)	LED Current at Ambient level 3h
12h	W	-	IU4(6)	IU4(5)	IU4(4)	IU4(3)	IU4(2)	IU4(1)	IU4(0)	LED Current at Ambient level 4h
13h	V	-	IU5(6)	IU5(5)	IU5(4)	IU5(3)	IU5(2)	IU5(1)	IU5(0)	LED Current at Ambient level 5h
14h	W	-	IU6(6)	IU6(5)	IU6(4)	IU6(3)	IU6(2)	IU6(1)	IU6(0)	LED Current at Ambient level 6h
15h	V	-	IU7(6)	IU7(5)	IU7(4)	IU7(3)	IU7(2)	IU7(1)	IU7(0)	LED Current at Ambient level 7h
16h	W	-	IU8(6)	IU8(5)	IU8(4)	IU8(3)	IU8(2)	IU8(1)	IU8(0)	LED Current at Ambient level 8h
17h	V	-	IU9(6)	IU9(5)	IU9(4)	IU9(3)	IU9(2)	IU9(1)	IU9(0)	LED Current at Ambient level 9h
18h	W	-	IUA(6)	IUA(5)	IUA(4)	IUA(3)	IUA(2)	IUA(1)	IUA(0)	LED Current at Ambient level Ah
19h	W	-	IUB(6)	IUB(5)	IUB(4)	IUB(3)	IUB(2)	IUB(1)	IUB(0)	LED Current at Ambient level Bh
1Ah	W	-	IUC(6)	IUC(5)	IUC(4)	IUC(3)	IUC(2)	IUC(1)	IUC(0)	LED Current at Ambient level Ch
1Bh	W	-	IUD(6)	IUD(5)	IUD(4)	IUD(3)	IUD(2)	IUD(1)	IUD(0)	LED Current at Ambient level Dh
1Ch	W	-	IUE(6)	IUE(5)	IUE(4)	IUE(3)	IUE(2)	IUE(1)	IUE(0)	LED Current at Ambient level Eh
1Dh	W	-	IUF(6)	IUF(5)	IUF(4)	IUF(3)	IUF(2)	IUF(1)	IUF(0)	LED Current at Ambient level Fh

Prohibit to accessing the address that isn't mentioned.

The timing indicated by explanation of registers, is a value in case built-in OSC has Typ. frequency.(1MHz)

Register Map

Address 00h < Software Reset >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
00h	W	-	-	-	-	-	-	-	SFTRST
Initial Value	00h	-	-	-	-	-	-	-	0

Bit [7:1]: (Not used)

Bit0: SFTRST Software Reset Command

"0": Reset cancel

"1": Reset (All register initializing) Refer to "Explanation 1" for detail.

Address 01h < LED, ALC Control >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
01h	R/W	-	VOVP(2)	VOVP(1)	VOVP(0)	WPWMEN	ALCEN	LEDMD	LEDEN
Initial Value	00h	-	0	0	0	0	0	0	0

Bit7: (Not used)

Bit [6:4]: VOVP(2:0) Over Voltage Protection detect voltage

"000": OVP=31V(typ) 8LED connection
"001": OVP=27V(typ) 7LED connection
"010": OVP=24V(typ) 6LED connection
"011": OVP=21V(typ) 5LED connection
"100": OVP=18V(typ) 4LED connection

"100": OVP=18V(typ)
"101": Don't use
"110": Don't use
"111": Don't use

Refer to "Explanation 4" for detail.

Bit3: WPWMEN External PWM Input "WPWMIN" terminal Enable Control (Valid/Invalid)

"0": WPWMIN input invalid
"1": WPWMIN input valid
Refer to "Explanation 5-(10)" for detail.

Bit2: ALCEN ALC Function Control (ON/OFF)

"0": ALC function OFF ALC function ON

Refer to "Explanation 5-(1)" for detail.

Bit1: LEDMD LED Mode Select (ALC mode/Register mode)

"0": Register mode "1": ALC mode

Refer to "Explanation 5-(1)" for detail.

Bit0: LEDEN LED Control (ON/OFF)

"0": LED OFF LED ON

Refer to "Explanation 5-(1)" for detail.

Address 03h < LED Current Setting at Register mode >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
03h	R/W	-	ILED(6)	ILED(5)	ILED(4)	ILED(3)	ILED(2)	ILED(1)	ILED(0)
Initial Value	00h	-	0	0	0	0	0	0	0

Bit7: (Not used)

Bit [6:0]: ILED(6:0) LED Current Setting at Register mode

"0000000":	0.2 mA	"1000000" :	13.0 mA
		1000000 .	
"0000001":	0.4 mA	"1000001" :	13.2 mA
"0000010":	0.6 mA	"1000010" :	13.4 mA
"0000010".			
"0000011":	0.8 mA	"1000011" :	13.6 mA
"0000100":	1.0 mA	"1000100" :	13.8 mA
"0000101":	1.2 mA	"1000101" :	14.0 mA
"0000110":	1.4 mA	"1000110":	14.2 mA
"0000111":	1.6 mA	"1000111" :	14.4 mA
"0001000":	1.8 mA	"1001000" :	14.6 mA
"0001001":	2.0 mA	"1001001" :	14.8 mA
"0001010":	2.2 mA	"1001010" :	15.0 mA
"0001011":	2.4 mA	"1001011" :	15.2 mA
"0001100":	2.6 mA	"1001100" :	15.4 mA
"0001100".		"4004404"	
"0001101":	2.8 mA	"1001101" :	15.6 mA
"0001110":	3.0 mA	"1001110" :	15.8 mA
"0001111":	3.2 mA	"1001111" :	16.0 mA
"0010000":	3.4 mA	"1010000" :	16.2 mA
"0040004"		"4040004"	
"0010001":	3.6 mA	"1010001" :	16.4 mA
"0010010":	3.8 mA	"1010010" :	16.6 mA
"0010011" :		"1010011" :	
	4.0 mA	1010011 .	16.8 mA
"0010100":	4.2 mA	"1010100" :	17.0 mA
"0010101":	4.4 mA	"1010101":	17.2 mA
"0010110":	4.6 mA	"1010110" :	17.4 mA
"0010111":	4.8 mA	"1010111":	17.6 mA
			17.6 IIIA
"0011000":	5.0 mA	"1011000" :	17.8 mA
"0011001":	5.2 mA	"1011001" :	18.0 mA
"0011010":	5.4 mA	"1011010" :	18.2 mA
"0011011":	5.6 mA	"1011011" :	18.4 mA
"0011011".			
"0011100":	5.8 mA	"1011100" :	18.6 mA
"0011101":	6.0 mA	"1011101" :	18.8 mA
"0011110":	6.2 mA	"1011110" :	19.0 mA
"0011111":	6.4 mA	"1011111":	19.2 mA
"0100000":	6.6 mA	"1100000":	19.4 mA
		1100000 .	
"0100001":	6.8 mA	"1100001" :	19.6 mA
"0100010":	7.0 mA	"1100010":	19.8 mA
"0100011":	7.2 mA	"1100011" :	20.0 mA
"0100100":	7.4 mA	"1100100" :	20.2 mA
"0100101":	7.6 mA	"1100101" :	20.4 mA
"0100110":	7.8 mA	"1100110" :	20.6 mA
		"4400444" .	
"0100111":	8.0 mA	"1100111" :	20.8 mA
"0101000":	8.2 mA	"1101000" :	21.0 mA
"0101001" :		"1101001" :	
	8.4 mA		21.2 mA
"0101010":	8.6 mA	"1101010" :	21.4 mA
"0101011":	8.8 mA	"1101011" :	21.6 mA
"0101100" :	9.0 mA	"1101100" :	21.8 mA
"0101101" :	9.2 mA	"1101101" :	22.0 mA
		"4404440"	
"0101110":	9.4 mA	"1101110" :	22.2 mA
"0101111":	9.6 mA	"1101111":	22.4 mA
"0110000":	9.8 mA	"1110000" :	22.6 mA
"0110001":	10.0 mA	"1110001" :	22.8 mA
"0110010":	10.2 mA	"1110010":	23.0 mA
0110010 .		1110010 .	
"0110011":	10.4 mA	"1110011" :	23.2 mA
"0110100":	10.6 mA	"1110100" :	23.4 mA
"0110101":	10.8 mA	"1110101" :	23.6 mA
"0110110":	11.0 mA	"1110110" :	23.8 mA
		"4440444"	
"0110111" :	11.2 mA	"1110111" :	24.0 mA
"0111000":	11.4 mA	"1111000" :	24.2 mA
"0111001":	11.6 mA	"1111001" :	24.4 mA
"0111010":	11.8 mA	"1111010" :	24.6 mA
"0111011":	12.0 mA	"1111011" :	24.8 mA
"0111100":	12.2 mA	"1111100" :	25.0 mA
"0111101":	12.4 mA	"1111101" :	25.2 mA
"0111110":		"111110":	25.4 mA
	12.6 mA		
"0111111":	12.8 mA	"1111111":	25.6 mA
			=

Address 08h < LED Current transition >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
08h	W	THL(3)	THL(2)	THL(1)	THL(0)	TLH(3)	TLH(2)	TLH(1)	TLH(0)
Initial Value	C7h	1	1	0	0	0	1	1	1

LED current Down transition per 0.2mA step Bit [7:4]: THL(3:0) "0000": 0.256 ms "0001": 0.512 ms "0010": 1.024 ms "0011": 2.048 ms "0100": 4.096 ms "0101": 8.192 ms "0110": 16.38 ms "0111": 32.77 ms "1000": 65.54 ms "1001": 131.1 ms "1010": 196.6 ms "1011": 262.1 ms "1100": 327.7 ms (Initial value) "1101": 393.2 ms "1110": 458.8 ms "1111": 524.3 ms

Refer to "Explanation 5-(8)" for detail.

Bit [3:0]: TLH(3:0) LED current Up transition per 0.2mA step "0000": 0.256 ms "0001": 0.512 ms "0010": 1.024 ms "0011": 2.048 ms "0100": 4.096 ms "0101": 8.192 ms "0110" : 16.38 ms "0111": 32.77 ms (Initial value) "1000": 65.54 ms "1001": 131.1 ms "1010": 196.6 ms "1011": 262.1 ms "1100": 327.7 ms "1101": 393.2 ms

Refer to "Explanation 5-(8)" for detail.

458.8 ms

524.3 ms

"1110":

"1111":

Address 0Bh < ALC mode setting >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
0Bh	R/W	ADCYC(1)	ADCYC(0)	GAIN(1)	GAIN(0)	STYPE	VSB	MDCIR	SBIASON
Initial Value	81h	1	0	0	0	0	0	0	1

Bit [7:6]: ADCYC(1:0) ADC Measurement Cycle

"00": 0.52 s"01": 1.05 s

"10": 1.57 s (Initial value)

"11": 2.10 s

Refer to "Explanation 5-(4)" for detail.

Bit [5:4]: **GAIN(1:0)** Sensor Gain Switching Function Control

> "00": Auto Change (Initial value)

"01": Manual High "10": Manual Low "11": Fixed

Refer to "Explanation 5-(3),5-(6)" for detail.

Ambient Light Sensor Type Select (Linear/Logarithm) Bit3: **STYPE**

For Linear Sensor (Initial value)

"0": "1": For Log Sensor

Refer to "Explanation 5-(6)" for detail.

Bit2: SBIAS Output Voltage Control **VSB**

"0": "1": SBIAS output voltage 3.0V (Initial value)

SBIAS output voltage 2.6V Refer to "Explanation 5-(2)" for detail.

Bit1: MDCIR LED Current Reset Select by Mode Change

> LED current non-reset at mode change (Initial value)

LED current reset at mode change

Refer to "Explanation 5-(9)" for detail.

SBIAS Control (ON/OFF) Bit0: SBIASON

Measurement cycle synchronous

Usually ON (at ALCEN=1) (Initial value)

Refer to "Explanation 5-(4)" for detail.

Address 0Dh < Ambient level (Read Only) >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
0Dh	R	-	-	-	-	AMB(3)	AMB(2)	AMB(1)	AMB(0)
Initial Value	-	-	-	-	-	-	-	-	-

Bit [7:4]: (Not used)

Bit [3:0] : **AMB(3:0)** Ambient Level "0000" : 0h

0h "0001": 1h "0010": "0011": 2h 3h "0100": 4h "0101": 5h "0110": 6h "0111": "1000": 7h 8h "1001": 9h "1010": Ah "1011": Bh "1100": Ch "1101": Dh "1110": "1111": Eh Fh

The data can be read through I²C. Refer to "Explanation 5-(6)" for detail.

Address 0Eh~1Dh < LED Current at Ambient level 0h~Fh >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
0Eh~1Dh	W	-	IU*(6)	IU*(5)	IU*(4)	IU*(3)	IU*(2)	IU*(1)	IU*(0)
Initial Value	-	Refer to "Explanation 5-(7)" for initial table							

"*" means 0~F.

Bit7: (Not used)

Bit [6:0]: IU*(6:0) LED Current at Ambient Level for 0h~Fh

"0000000":	0.2 mA	"1000000":	13.0 mA
"0000001":	0.4 mA	"1000001":	13.2 mA
"0000010":	0.6 mA	"1000010" :	13.4 mA
"0000011":	0.8 mA	"1000011" :	13.6 mA
"0000100":	1.0 mA	"1000100":	13.8 mA
"0000101":	1.2 mA	"1000101":	14.0 mA
"0000110":	1.4 mA	"1000110":	14.2 mA
"0000111":	1.6 mA	"1000111" :	14.4 mA
"0001000":	1.8 mA	"1001000" :	14.6 mA
"0001001":	2.0 mA	"1001001":	14.8 mA
"0001010":	2.2 mA	"1001010" :	15.0 mA
"0001011":	2.4 mA	"1001011" :	15.2 mA
"0001100":	2.6 mA	"1001100" :	15.4 mA
"0001101":	2.8 mA	"1001101" :	15.6 mA
"0001110":	3.0 mA	"1001110":	15.8 mA
"0001111":	3.2 mA	"1001111":	16.0 mA
"0010000":	3.4 mA	"1010000" :	16.2 mA
"0010001":	3.6 mA	"1010001":	16.4 mA
"0010010":	3.8 mA	"1010010" :	16.6 mA
"0010011":	4.0 mA	"1010011":	16.8 mA
"0010100":	4.2 mA	"1010100":	17.0 mA
"0010101":	4.4 mA	"1010101":	17.2 mA
"0010110":	4.6 mA	"1010110" : "1010111" :	17.4 mA
"0010111" : "0011000" :	4.8 mA	"1010111" : "1011000" :	17.6 mA
"0011000":	5.0 mA	"1011000":	17.8 mA
"0011001":	5.2 mA 5.4 mA	"1011011":	18.0 mA 18.2 mA
"0011010":	5.4 mA	"1011010":	18.4 mA
"0011100":	5.8 mA	"1011100" :	18.6 mA
"0011100":	6.0 mA	"1011100":	18.8 mA
"001110":	6.2 mA	"1011110" :	19.0 mA
"0011110":	6.4 mA	"1011111":	19.2 mA
"0100000":	6.6 mA	"1100000":	19.4 mA
"0100001":	6.8 mA	"1100001" :	19.6 mA
"0100010":	7.0 mA	"1100010" :	19.8 mA
"0100011":	7.2 mA	"1100011" :	20.0 mA
"0100100":	7.4 mA	"1100100" :	20.2 mA
"0100101":	7.6 mA	"1100101" :	20.4 mA
"0100110":	7.8 mA	"1100110" :	20.6 mA
"0100111":	8.0 mA	"1100111" :	20.8 mA
"0101000":	8.2 mA	"1101000" :	21.0 mA
"0101001":	8.4 mA	"1101001" :	21.2 mA
"0101010":	8.6 mA	"1101010":	21.4 mA
"0101011":	8.8 mA	"1101011":	21.6 mA
"0101100":	9.0 mA	"1101100" :	21.8 mA
"0101101":	9.2 mA	"1101101": "11011101":	22.0 mA
"0101110":	9.4 mA	"1101110" : "1101111" :	22.2 mA
"0101111" : "0110000" :	9.6 mA 9.8 mA	"1101111" : "1110000" :	22.4 mA 22.6 mA
"0110000":	10.0 mA	"1110000":	22.8 mA
"0110001":	10.0 mA	"1110010":	23.0 mA
"0110010":	10.2 mA	"1110010":	23.0 mA
"0110100":	10.4 mA	"1110100" :	23.4 mA
"0110100":	10.8 mA	"1110100":	23.6 mA
"0110110" :	11.0 mA	"1110110" :	23.8 mA
"0110111" :	11.2 mA	"1110111" :	24.0 mA
"0111000" :	11.4 mA	"1111000" :	24.2 mA
"0111001":	11.6 mA	"1111001" :	24.4 mA
"0111010":	11.8 mA	"1111010" :	24.6 mA
"0111011":	12.0 mA	"1111011" :	24.8 mA
"0111100":	12.2 mA	"1111100" :	25.0 mA
"0111101":	12.4 mA	"1111101":	25.2 mA
"0111110":	12.6 mA	"1111110" :	25.4 mA
"0111111":	12.8 mA	"1111111":	25.6 mA

●Contents of "Explanation for operate"

- 1. Reset
 - (1) Software reset
 - (2) Hardware reset
 - (3) Reset sequence
- 2. Thermal shutdown
- 3. DC/DC for LED Driver
- Protection function
 - (1) Over voltage protection
 - (2) Over current protection
 - (3) VOUT short to GND protection
 - (4) VOUT open protection
- ALC (Auto Luminous Control) and LED Driver
 ALC ON/OFF

 - (2) I/V conversion
 - (3) Sensor Gain control
 - (4) A/D conversion(5) Average filter

 - (6) Ambient level detection
 - (7) LED current assignment
 - (8) Slope process
 - (9) LED current reset at mode change
 - (10) Current adjustment (External PWM)
- 6. I/O
- The unused terminal

Explanation for operate

1. Reset

There are two kinds of reset, software reset and hardware reset.

- (1) Software reset
 - · All the registers are initialized more than making a register (SFTRST) setup "1".
 - The register of software resetting is an automatic return (Auto Return 0).

(2) Hardware reset

- RESETB pin "H" → "L" to shift hardware reset.
- Under hardware reset, all registers and output pins are initialized, and I²C access are stopped.
- RESETB pin "L" → "H" to release from hardware reset
- RESETB pin has delay circuit. It doesn't recognize as hardware reset in "L" period under 5µs.

(3) Reset Sequence

• When hardware reset was done during software reset, software reset is canceled when hardware reset is canceled. (Because the initial value of software reset is "0")

2. Thermal shutdown

Thermal shutdown function is effective in the following blocks.

DC/DC

LED Driver

A thermal shutdown function works in about 190°C.

Detection temperature has a hysteresis, and detection release temperature is about 170°C. (Design reference value)

3. DC/DC for LED driver

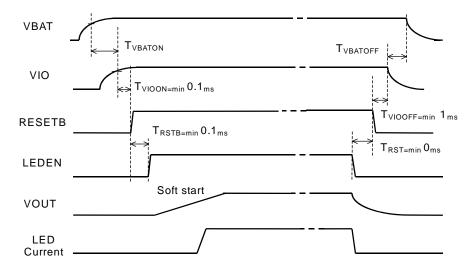
DC/DC block is designed for the power supply for LED driver.

Start

DC/DC circuit operates when LEDEN turns ON.

Soft start

Soft start function built-in to prevent rush current at start of the DC/DC.



4. Protection function

(1) Over voltage protection

Over Voltage Protection prevents the over-voltage of the VOUT terminal. If the VOUT voltage is over detect voltage, it stopping DC/DC switching. After stopping the switching, if VOUT is drop under un-detect voltage, the switching is re-start.

The OVP voltage can be changed by the register.

It is possible that an OVP voltage is set up suitably in accordance with the Vf and the number of LED that you use. Set it up toward an approximate goal of the following formula.

OVP voltage \geq (LED number) x (LED Vf max) +1 [V]

(2) Over current protection

Switching Overcurrent detection is done by the resistance arranged under the switching Tr. If it detect over current level, it is stopping DC/DC switching. Switching begins again when a state of over-current is canceled.

(3) VOUT short to GND protection

The detection of a state of ground short of the VOUT terminal.

DC/DC switching does stop at the time of the detection. Switching begins again when a state of detection is canceled.

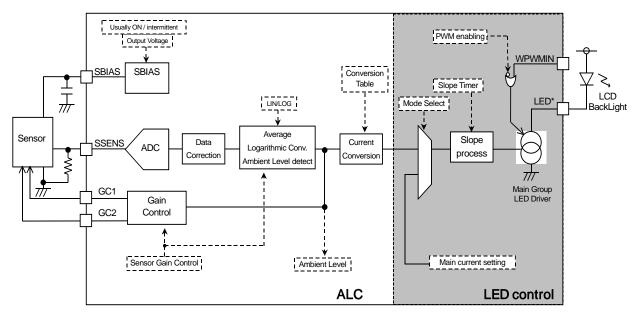
(4) VOUT open protection

The detection of a state of Open of the VOUT terminal.

DC/DC switching does stop at the time of the detection. Switching begins again when a state of detection is canceled.

5. The explanation of ALC (Auto Luminous Control)

- LCD backlight current adjustment is possible in the basis of ambient brightness by external sensor.
- Extensive selection of the ambient light sensors (Photo Diode, Photo Transistor, Photo IC(linear)) is possible by built-in adjustment feature of Sensor bias, ADC with average filter and logarithm conversion.
- Ambient brightness is changed into ambient level by digital data processing, and it can be read through I²C I/F.
- Register setting can customize a conversion to LED current. (Initial value is pre-set.)
- Natural dimming of LED driver is possible with the adjustment of the current transition speed.



^{*} Wave form in this explanation just shows operation image, not shows absolute value precisely.

(1) Auto Luminous Control ON/OFF

- · ALC block can be independent setting ON/OFF.
- It can use only to measure the Ambient level.

Register : ALCEN Register : LEDEN Register : LEDMD

· Refer to under about the associate ALC mode and LED current.

ALCEN	LEDEN	LEDMD	ALC	LED control	Mode	LED current
0	0	*	OFF	OFF	OFF	OFF
0	1	0	OFF	ON	Resister	ILED(6:0)
0	1	1	(AMB(3:0)=0h)	ON	mode	IU0(6:0) (*1)
1	0	*		OFF		OFF
1	1	0	ON	011	ALC mode	ILED(6:0)
1	1	1		ON		ALC mode (*2)

^(*1) LED current is selected IU0(6:0), because of ALC is OFF, AMB(3:0)=0h.

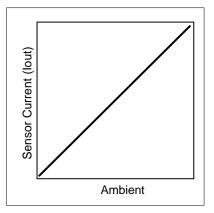
^(*2) LED current is selected IU0(6:0)~IUF(6:0) corresponding to each ambient level.

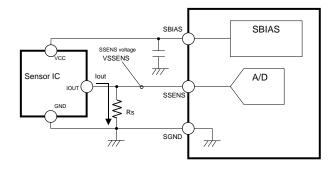
(2) I/V conversion

- The bias voltage and external resistance for the I-V conversion (Rs) are adjusted with adaptation of sensor characteristic
- The bias voltage is selectable by register setup.

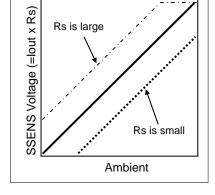
Register: VSB

"0": SBIAS output voltage 3.0V
"1": SBIAS output voltage 2.6V





Rs: Sense resistance (A sensor output current is changed into the voltage value.) SBIAS: Bias power supply terminal for the sensor (3.0V / 2.6V by register setting) SSENS: Sense voltage input terminal



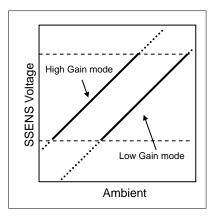
SSENS Voltage = lout x Rs

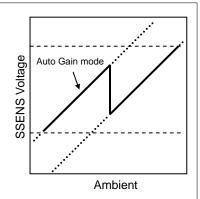
(3) Sensor Gain control

- Sensor gain switching function is built in to extend the dynamic range.
- It is controlled by register setup.
- When automatic gain control is off, the gain status can be set up in the manual.

Register: GAIN(1:0)

• GC1 and GC2 are outputted corresponding to each gain status.





	Example	Example 1 (Use BH1600FVC)			Example 2		Example 3
Application example	VCC IOUT BH1600 GC1 GND GC2	SBIA SSE	NNS .	((,)) 9:6	# T S S S S S S S S S	SND	SBIAS SSENS SSENS GC1 GC2 SGND
		Mai	nual		Mai	nual	i -
Operating mode	Auto	High	Low	Auto	High	Low	Fixed
GAIN(1:0) setting	00	01	10	00	01	10	11
Gain status	High Low	High	Low	High Low	High	Low	-
GC1 output	ΛL	Л	L	ЛГ	Л	L	Л
GC2 output	LЛ	L	Л	LЛ	L	Л	L

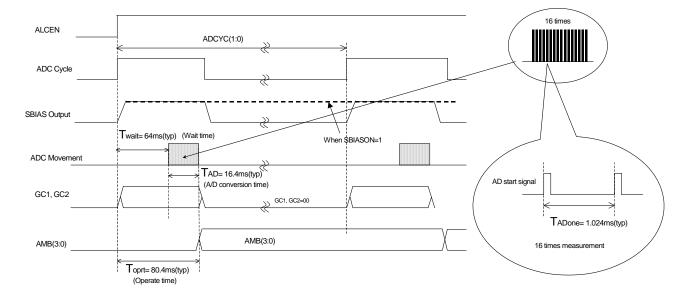
 $[\]prod$: This means that it becomes High with A/D measurement cycle synchronously.

^{(*1):} Set up the relative ratio of the resistance in the difference in the brightness change of the High Gain mode and the Low Gain mode carefully.

(4) A/D conversion

- The detection of ambient data is done periodically for the low power.
- SBIAS and ADC are turned off except for the ambient measurement.
- The sensor current may be shut in this function, it can possible to decrease the current consumption.
- · SBIAS pin and SSENS pin are pull-down in internal when there are OFF.
- SBIAS circuit has the two modes. (Usually ON mode or intermittent mode)

Register : ADCYC(1:0) Register : SBIASON



(5) Average filter

- Average filter is built in to rid noise or flicker.
- 16 times averaging.

(6) Ambient level detection

· Averaged A/D value is converted to Ambient level corresponding to Gain control and sensor type.

Ambient level is judged to rank of 16 steps by ambient data.

• The type of ambient light sensor can be chosen by register.

(Linear type sensor / Logarithm type sensor)

Register: STYPE
"0": For Linear sensor
"1": For Log sensor

Ambient level is output through I²C.

Register: AMB(3:0)

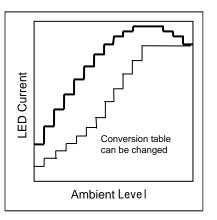
STYPE			0			1
GAIN(1:0)	0	0	10	01	11	XX
Gain Status	Auto Low	Auto High	Manual Low	Manual High	Fixed	Fixed
Ambient level			SSENS	voltage		
0h		VoS×0/256		VoS×0/256	VoS×0/256	VoS×0/256 VoS×17/256
1h		VoS×1/256		VoS×1/256	VoS×1/256	VoS × 18/256 VoS × 26/256
2h	This area is not assigned.	VoS×2/256	This area is not assigned.	VoS×2/256	VoS×2/256	VoS × 27/256 VoS × 36/256
3h		VoS × 3/256 VoS × 4/256		VoS×3/256 VoS×4/256	VoS × 3/256 VoS × 4/256	VoS × 37/256 VoS × 47/256
4h		VoS×5/256 VoS×7/256		VoS×5/256 VoS×7/256	VoS×5/256 VoS×6/256	VoS × 48 / 256 VoS × 59 / 256
5h	VoS×0/256	VoS × 8/256 VoS × 12/256	VoS×0/256	VoS×8/256 VoS×12/256	VoS×7/256 VoS×9/256	VoS × 60 / 256 VoS × 71 / 256
6h	VoS×1/256	VoS × 13/256 VoS × 21/256	VoS×1∕256	VoS × 13/256 VoS × 21/256	VoS×10/256 VoS×13/256	VoS×72/256 VoS×83/256
7h	VoS×2/256 VoS×3/256	VoS × 22 / 256 VoS × 37 / 256	VoS×2/256 VoS×3/256	VoS × 22 / 256 VoS × 37 / 256	VoS×14/256 VoS×19/256	VoS × 84/256 VoS × 95/256
8h	VoS×4/256 VoS×6/256	VoS × 38/256 VoS × 65/256	VoS×4/256 VoS×6/256	VoS × 38 / 256 VoS × 65 / 256	VoS×20/256 VoS×27/256	VoS × 96/256 VoS × 107/256
9h	VoS×7/256 VoS×11/256	VoS × 66/256 VoS × 113/256	VoS×7/256 VoS×11/256	VoS × 66/256 VoS × 113/256	VoS×28/256 VoS×38/256	VoS×108/256 VoS×119/256
Ah	VoS × 12/256 VoS × 20/256	VoS × 114/256 VoS × 199/256	VoS × 12/256 VoS × 20/256	VoS×114/256 VoS×199/256	VoS × 39 / 256 VoS × 53 / 256	VoS×120/256 VoS×131/256
Bh	VoS × 21 / 256 VoS × 36 / 256	VoS × 200 / 256 VoS × 255 / 256	VoS × 21 / 256 VoS × 36 / 256	VoS × 200 / 256 VoS × 255 / 256	VoS×54/256 VoS×74/256	VoS×132/256 VoS×143/256
Ch	VoS × 37/256 VoS × 64/256	/ 100 200 200	VoS × 37 / 256 VoS × 64 / 256	/ / /	VoS×75/256 VoS×104/256	VoS×144/256 VoS×155/256
Dh	VoS × 65 / 256 VoS × 114 / 256	This area is	VoS × 65 / 256 VoS × 114 / 256	This area is	VoS × 105 / 256 VoS × 144 / 256	VoS × 156 / 256 VoS × 168 / 256
Eh	VoS × 115 / 256 VoS × 199 / 256	not assigned.	VoS × 115 / 256 VoS × 199 / 256	not assigned.	VoS × 145 / 256 VoS × 199 / 256	VoS × 169 / 256 VoS × 181 / 256
Fh	VoS × 200 / 256 VoS × 255 / 256		VoS × 200 / 256 VoS × 255 / 256		VoS × 200 / 256 VoS × 255 / 256	VoS × 182 / 256 VoS × 255 / 256

• In the Auto Gain control mode, sensor gain changes in gray-colored ambient level.

(7) LED current assignment

- LED current can be assigned as each of 16 steps of the ambient level.
- Register setting can customize a conversion to LED current. (Initial value is pre-set.)

Register: IU*(6:0)



Conversion Table (initial value)

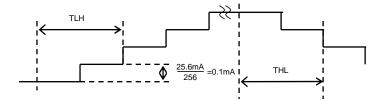
Conversion rable (initial value)							
Ambient Level	Setting data	Current value	Ambient Level	Setting data	Current value		
0h	11h	3.6mA	8h	48h	14.6mA		
1h	13h	4.0mA	9h	56h	17.4mA		
2h	15h	4.4mA	Ah	5Fh	19.2mA		
3h	18h	5.0mA	Bh	63h	20.0mA		
4h	1Eh	6.2mA	Ch	63h	20.0mA		
5h	25h	7.6mA	Dh	63h	20.0mA		
6h	2Fh	9.6mA	Eh	63h	20.0mA		
7h	3Bh	12.0mA	Fh	63h	20.0mA		

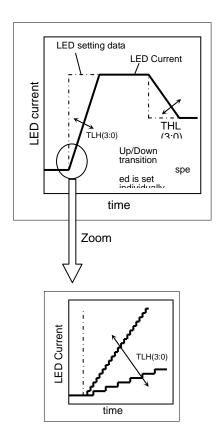
(8) Slope process

- Slope process is given to LED current to dim naturally.
- · LED current changes in the 256Step gradation in sloping.
- Up(dark→bright),Down(bright→dark) LED current transition speed are set individually.

Register: THL(3:0) Register: TLH(3:0)

LED current changes as follows at the time as the slope.
 TLH (THL) is setup of time of the current step 2/256.





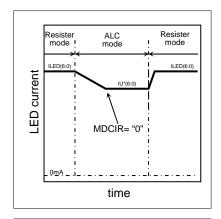
(9) LED current reset when mode change

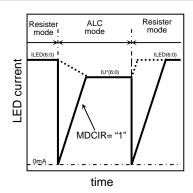
· Selectable the way to sloping at mode change.

(ALC↔Resister) Register : MDCIR

"0": LED current non-reset at mode change

"1": LED current reset at mode change





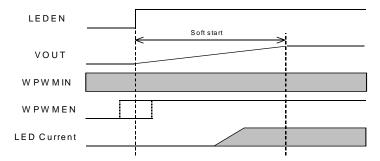
(10) Current adjustment (External PWM)

• PWM drive by the external terminal (WPWMIN) is possible with permission by the register setting.

Register: WPWMEN

It is suitable for the intensity correction by external control, because PWM based on LED current of register setup or ALC control.

WPWMEN	WPWMIN (External input)	LED current				
0	L	ON	D)A/A A :			
0	Н	ON PWM input inva				
1	L	Forced OFF	DWM isput valid			
1	Н	ON	PWM input valid			



WPWMIN input before LEDEN=1 is enable.

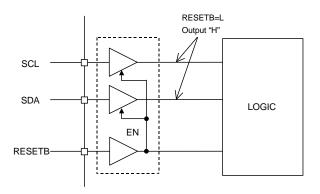
Setting PWMEN=1 before LEDEN=1 is enable.

PWM control is effective at the LED current rises up.

PWM "H" pulse width must be more than 50μ s.

6. The explanation of I/O

When the RESETB pin "L", the input buffers (SDA and SCL) are disabling for the low consumption power.



7. The unused terminal

Set up of the unused terminal is follows.

T1, T4: Short to ground

T2, T3 : Open GC1, GC2 : Open

Notes for use

(1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

(2) Power supply and ground line

Design PCB pattern to provide low impedance for the wiring between the power supply and the ground lines. Pay attention to the interference by common impedance of layout pattern when there are plural power supplies and ground lines. Especially, when there are ground pattern for small signal and ground pattern for large current included the external circuits, please separate each ground pattern. Furthermore, for all power supply pins to ICs, mount a capacitor between the power supply and the ground pin. At the same time, in order to use a capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

(3) Ground voltage

Make setting of the potential of the ground pin so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no pins are at a potential lower than the ground voltage including an actual electric transient.

(4) Short circuit between pins and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between pins or between the pin and the power supply or the ground pin, the ICs can break down.

(5) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

(6) Input pins

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input pin. Therefore, pay thorough attention not to handle the input pins, such as to apply to the input pins a voltage lower than the ground respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input pins when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input pins a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

(7) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

(8) Thermal shutdown circuit (TSD)

This LSI builds in a thermal shutdown (TSD) circuit. When junction temperatures become detection temperature or higher, the thermal shutdown circuit operates and turns a switch OFF. The thermal shutdown circuit, which is aimed at isolating the LSI from thermal runaway as much as possible, is not aimed at the protection or guarantee of the LSI. Therefore, do not continuously use the LSI with this circuit operating or use the LSI assuming its operation.

(9) Thermal design

Perform thermal design in which there are adequate margins by taking into account the permissible dissipation (Pd) in actual states of use.

(10) About the pin for the test, the un-use pin

Prevent a problem from being in the pin for the test and the un-use pin under the state of actual use. Please refer to a function manual and an application notebook. And, as for the pin that doesn't specially have an explanation, ask our company person in charge.

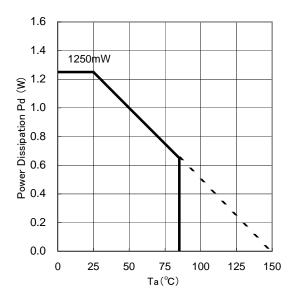
(11) About the rush current

For ICs with more than one power supply, it is possible that rush current may flow instantaneously due to the internal powering sequence and delays. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of wiring.

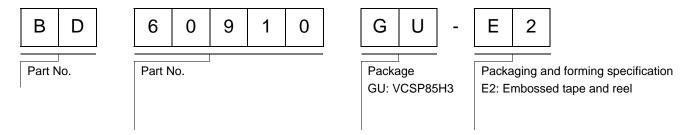
(12) About the function description or application note or more.

The function description and the application notebook are the design materials to design a set. So, the contents of the materials aren't always guaranteed. Please design application by having fully examination and evaluation include the external elements.

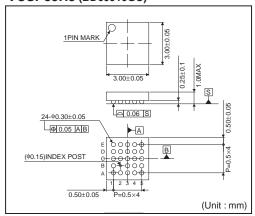
●Power dissipation (On the ROHM's Power dissipation measuring board)

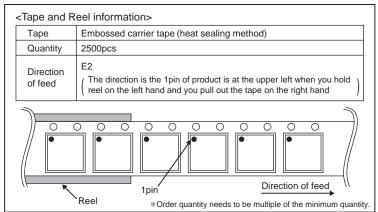


Ordering part number



VCSP85H3 (BD60910GU)





Notes

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